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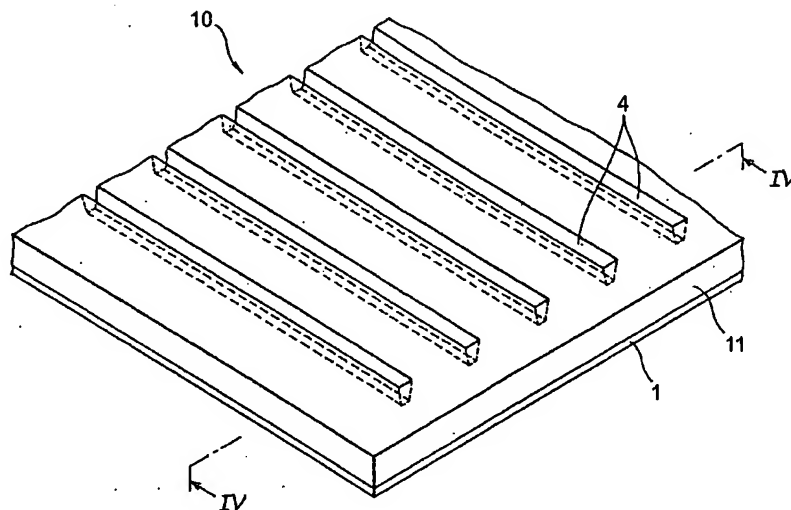
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(54) Title: FLEXIBLE MOLD, METHOD OF MANUFACTURING SAME AND METHOD OF MANUFACTURING FINE
STRUCTURES



(57) Abstract: A flexible mold (10) having a mold layer (11) that is provided on the surface thereof with a groove pattern (4) of specified shape and size, is constructed such that the mold layer contains a lithium salt of an organic fluorine compound as an antistatic agent.

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